

MOS FIELD EFFECT TRANSISTOR 2SK3115

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3115 is N-Channel DMOS FET device that features a low gate charge and excellent switching haracteristics, and designed for high voltage applications such as switching power supply, AC adapter.

FEATURES

- Low gate charge $Q_{G} = 26 \ nC \ TYP. \ (V_{DD} = 450 \ V, \ V_{GS} = 10 \ V, \ I_{D} = 6.0 \ A)$
- Gate voltage rating ± 30 V
- Low on-state resistance
- $R_{DS(on)} = 1.2 \Omega MAX. (V_{GS} = 10 V, I_{D} = 3.0 A)$
- Avalanche capability ratings

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3115	Isolated TO-220

(Isolated TO-220)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Vdss	600	V
Vgss	±30	V
D(DC)	±6.0	А
D(pulse)	±24	А
P T1	2.0	W
P T2	35	W
Tch	150	°C
Tstg	-55 to +150	°C
AS	6.0	А
Eas	24	mJ
	VGSS ID(DC) ID(pulse) PT1 PT2 Tch Tstg IAS	VGSS ±30 ID(DC) ±6.0 ID(pulse) ±24 PT1 2.0 PT2 35 Tch 150 Tstg -55 to +150 IAS 6.0

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting $T_{ch} = 25^{\circ}C$, VDD = 150 V, RG = 25 Ω , VGS = 20 \rightarrow 0 V

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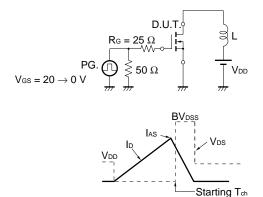
The mark \star shows major revised points.

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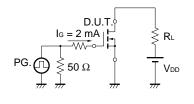
ELECTRICAL CHARACTERISTICS (TA = 25°C)

Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	loss	Vds = 600 V, Vgs = 0 V			100	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 30 \text{ V}, \text{ Vds} = 0 \text{ V}$			±100	nA
Gate Cut-off Voltage	V _{GS(off)}	Vds = 10 V, Id = 1 mA	2.5		3.5	V
Forward Transfer Admittance	y _{fs}	Vds = 10 V, Id = 3.0 A	2.0			S
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, Id = 3.0 A		0.9	1.2	Ω
Input Capacitance	Ciss	V _{DS} = 10 V		1100		pF
Output Capacitance	Coss	V _{GS} = 0 V		200		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		20		pF
Turn-on Delay Time	td(on)	Vdd = 150 V, Id = 3.0 A		18		ns
Rise Time	tr	VGS(on) = 10 V		12		ns
Turn-off Delay Time	$t_{d(off)}$	$R_G = 10 \Omega$, $R_L = 50 \Omega$		50		ns
Fall Time	tr			15		ns
Total Gate Charge	Q _G	Vdd = 450 V		26		nC
Gate to Source Charge	Qgs	Vgs = 10 V		6		nC
Gate to Drain Charge	Qgd	ID = 6.0 A		10		nC
Body Diode Forward Voltage	VF(S-D)	IF = 6.0 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 6.0 A, VGS = 0 V		1.4		μs
Reverse Recovery Charge	Qrr	di/dt = 50 A/ μ s		6.5		μC

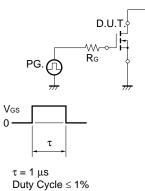
* TEST CIRCUIT 1 AVALANCHE CAPABILITY

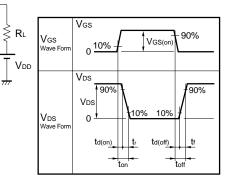


TEST CIRCUIT 3 GATE CHARGE



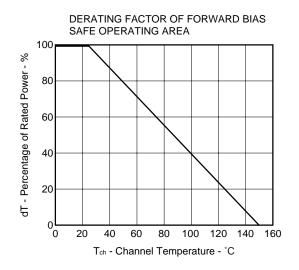
TEST CIRCUIT 2 SWITCHING TIME

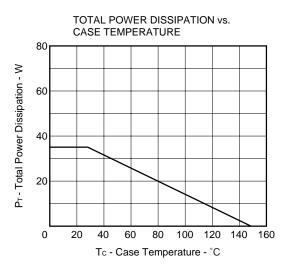




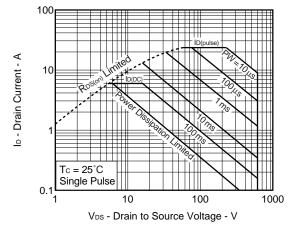
Data Sheet D13338EJ2V0DS

***** TYPICAL CHARACTERISTICS (T_A = 25°C)

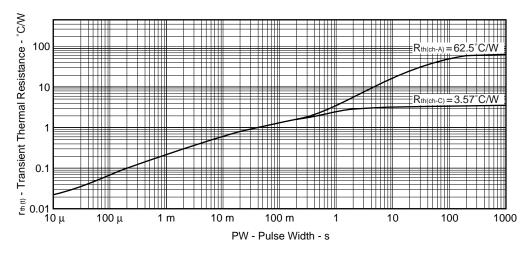




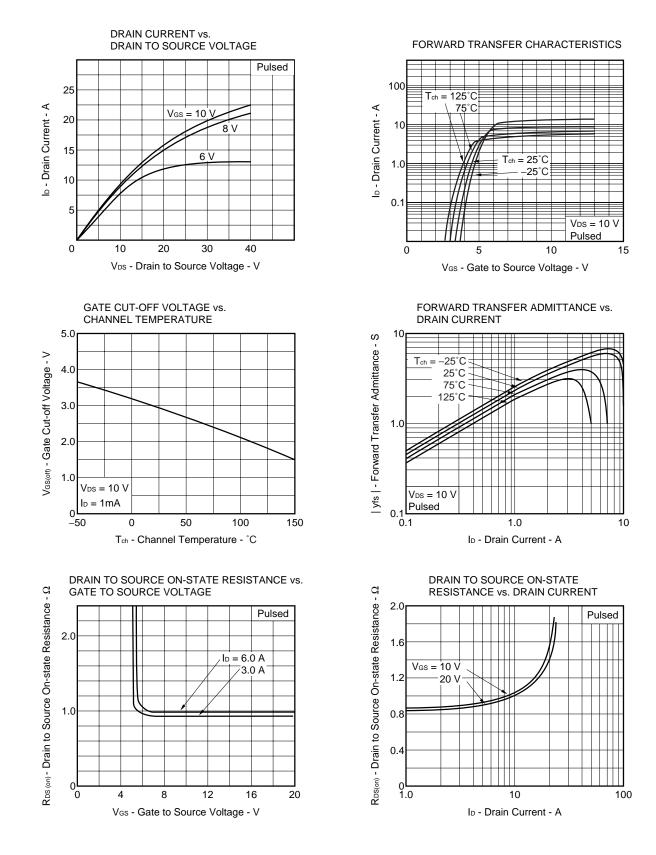
FORWARD BIAS SAFE OPERATING AREA



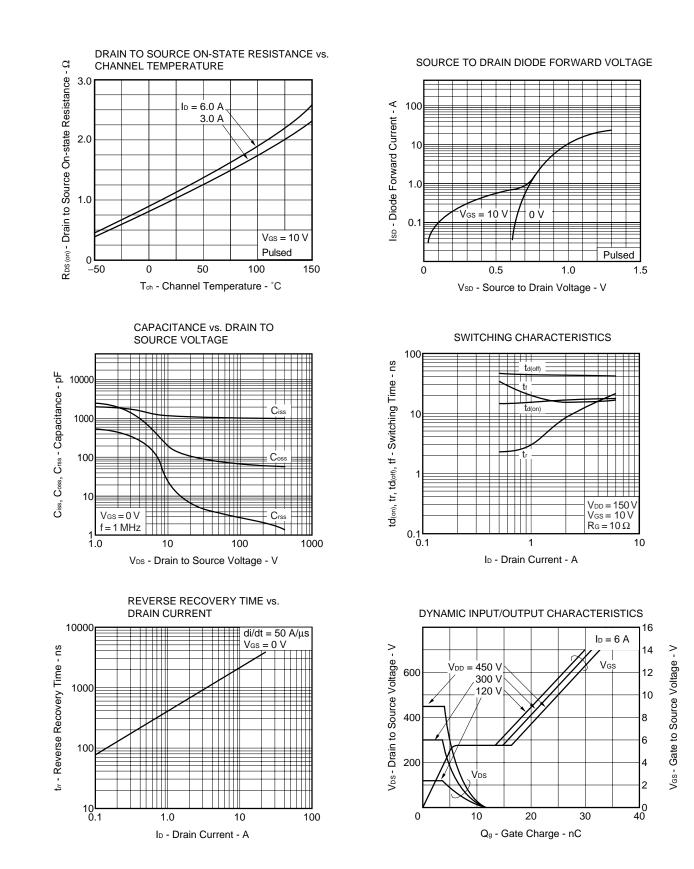
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



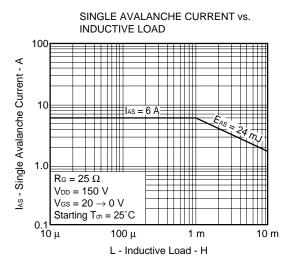
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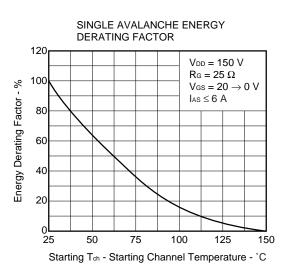


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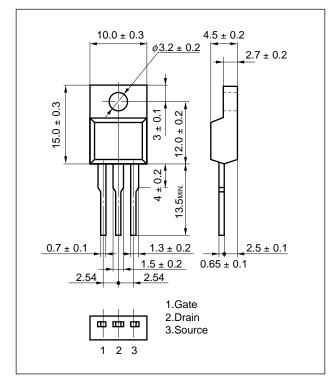
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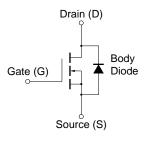


PACKAGE DRAWING (Unit: mm)

Isolated TO-220(MP-45F)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Data Sheet D13338EJ2V0DS

[MEMO]

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